

Title (en)

DEVICE FOR SELECTIVELY PROCESSING INDIVIDUAL COMPONENTS OF A FLAT ELECTRONIC SUB-ASSEMBLY

Title (de)

VORRICHTUNG ZUM SELEKTIVEN BEARBEITEN EINZELNER BAUTEILE EINER ELEKTRONISCHEN FLACHBAUGRUPPE

Title (fr)

DISPOSITIF PERMETTANT DE TRAVAILLER DE FA ON SELECTIVE SUR DES COMPOSANTS INDIVIDUELS D'UN ENSEMBLE PLAT ELECTRONIQUE

Publication

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Application

**EP 98912208 A 19980212**

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- DE 19716392 A 19970418

Abstract (en)

[origin: DE19716392A1] The invention relates to a device for selectively processing on individual components of a flat electronic sub-assembly in predetermined ambient conditions. This device comprises a receptacle for lodging the sub-assembly module, the cover surface (18) of which has an opening (44) for inserting a working tool. The opening (44) is formed excentrically in a disc (52) which is rotationally mounted in the covering surface (18).

IPC 1-7

**H05K 13/04**

IPC 8 full level

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